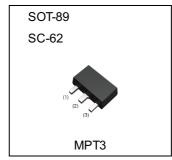
Middle Power Transistor (-60V/-2A)

Parameter	Value
V _{CEO}	-60V
IC	-2A

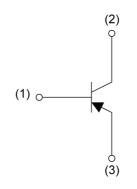
Outline



Features

- 1)Low saturation voltage, tipically $V_{CE(sat)}$ =-150mV at I_C/I_B =-1A/-50mA.
- 2)Collector-emitter voltage=-60V
- 3) P_D =2W (Mounted on a ceramic board (40×40×0.7mm)).
- 4)Complementary NPN Types: 2SD2391

•Inner circuit



- (1) Base
- (2) Collector
- (3) Emitter

Application

LOW FREQUENCY AMPLIFIER

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
2SB1561	SOT-89 (MPT3)	4540	T100	180	12	1000	BL

● Absolute maximum ratings (T_a = 25°C)

Parameter	Symbol	Values	Unit
Collector-base voltage	V_{CBO}	-60	V
Collector-emitter voltage	V _{CEO}	-60	V
Emitter-base voltage	V _{EBO}	-6	V
		-2	Α
Collector current	I _{CP} *1	-6	Α
Daniel dia dia atta		0.5	W
Power dissipation	P _D *3	2.0	W
Junction temperature	T _j	150	°C
Range of storage temperature	T _{stg}	-55 to +150	ဇ

• Electrical characteristics $(T_a = 25^{\circ}C)$

Davameter	Cymahal	Canditions	Values			1.1:4	
Parameter	Symbol Conditions		Min.	Тур.	Max.	Unit	
Collector-base breakdown voltage	akdown BV_{CBO} $I_C = -50\mu A$		-60	-	-	V	
Collector-emitter breakdown voltage	BV _{CEO}	I _C = -1mA	-60	-	-	V	
Emitter-base breakdown voltage	BV _{EBO}	I _E = -50μA	-6	-	-	V	
Collector cut-off current	I _{CBO}	V _{CB} = -50V	ı	1	-100	nA	
Emitter cut-off current	I _{EBO}	V _{EB} = -5V	ı	-	-100	nA	
Collector-emitter saturation voltage	V _{CE(sat)} *4	$I_C = -1A$, $I_B = -50mA$	ı	-150	-350	mV	
DC augrant gain	h _{FE} 1*4	$V_{CE} = -2V, I_{C} = -500 \text{mA}$	82	170	270	_	
DC current gain	h _{FE} 2*4	$V_{CE} = -2V, I_{C} = -1.5A$	45	-	-	-	
Transition frequency	f _T *3	$V_{CE} = -2V, I_{E} = -500 \text{mA},$ f = 100MHz	-	200	-	MHz	
Output capacitance	C _{ob}	$V_{CB} = -10V, I_E = 0A,$ f = 1MHz	-	23	-	pF	

hFE values are calssified as follows:

rank	Р	Q	-	-	-
h _{FE} 1	82-180	120-270	-	-	-

^{*1} Pw=10ms, Single Pulse

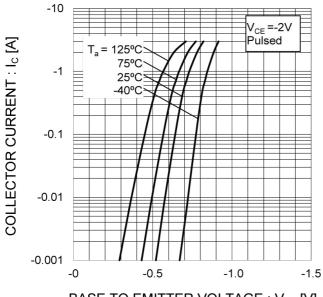
^{*2} Each terminal mounted on a reference land.

^{*3} Mounted on a ceramic board.(40×40×0.7mm)

^{*4} Pulsed

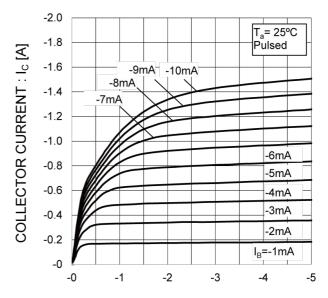
● Electrical characteristic curves(T_a = 25°C)

Fig.1 Grounded emitter output characteristics



BASE TO EMITTER VOLTAGE: VBE [V]

Fig.2 Ground emitter propagation characteristics



COLLECTOR TO EMITTER VOLTAGE: VCE [V]

Fig.3 DC current gain vs. collector current (I)

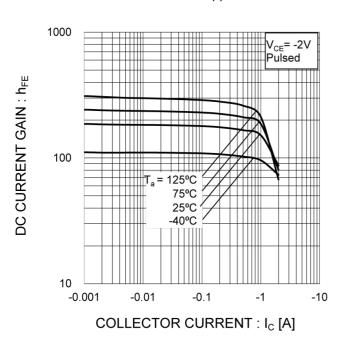
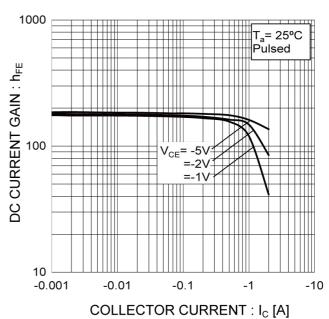


Fig.4 DC current gain vs. collector current (II)



● Electrical characteristic curves(T_a = 25°C)

Fig.5 Collector-emitter saturation voltage vs. collector current (I)

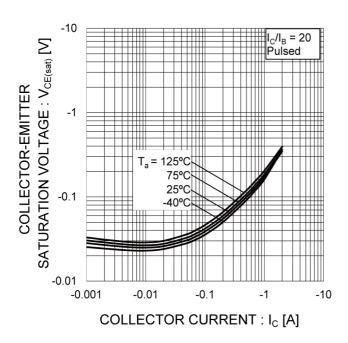


Fig.6 Collector-emitter saturation voltage vs. collector current (II)

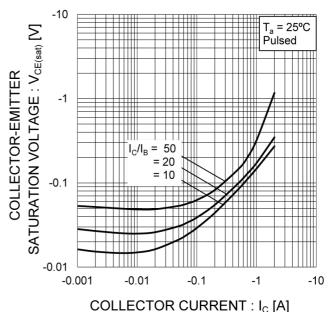


Fig.7 Base-Emitter Saturation Voltage vs. Collector Current

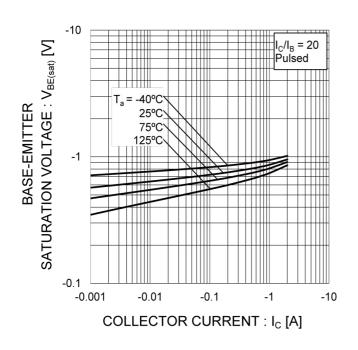
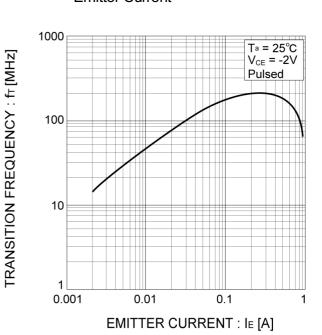


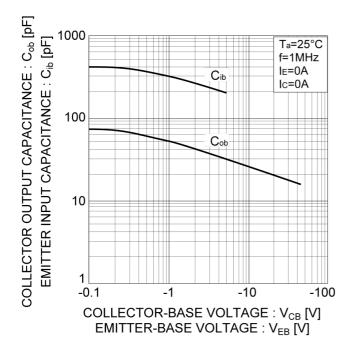
Fig.8 Gain Bandwidth Product vs. Emitter Current

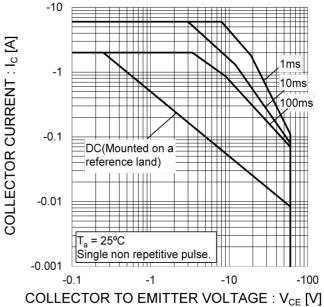


● Electrical characteristic curves(T_a = 25°C)

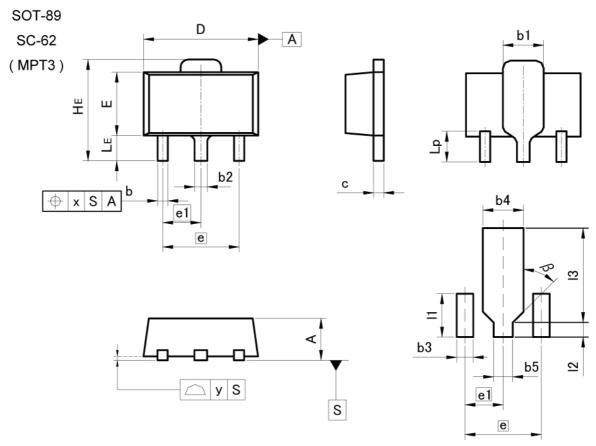
Fig.9 Emitter Input Capacitance vs.
Emitter-Base Voltage
Collector Output Capacitance vs.
Collector-Base Voltage

Fig.10 Safe Operating Area





Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM MILI		ETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
Α	1.40	1.60	0.055	0.063	
b	0.30	0.50	0.012	0.020	
b1	1.50	1.70	0.059	0.067	
b2	0.40	0.60	0.016	0.024	
С	0.35	0.50	0.014	0.020	
D	4.40	4.70	0.173	0.185	
E	2.40	2.70	0.094	0.106	
е	3.	00	0.118		
e1	1.	50	0.0	159	
HE	3.70	4.30	0.146	0.169	
LE	0.80	1.20	0.031	0.047	
Lp	1.01	1.41	0.040	0.056	
х		0.15	-:	0.006	
У	-	0.10	-	0.004	

DIM	MILIM	ETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
b3	-	0.65	-	0.026	
b4	_	1.70	1	0.067	
b5	- ->	0.75	= 1	0.030	
- 11	-1	1.71	-	0.067	
12	-/	0.58	ī	0.023	
13	20	3.72	_	0.146	
β	45°		45	0	

Dimension in mm/inches



Notice

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(Note1) Medical Equipment Classification of the Specific Applications

1 /	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1		
JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSIII	CLASS II b	CL ACCTI
CLASSIV	CLASSIII	CLASSⅢ	CLASSⅢ

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 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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